

Global and China Semiconductor Packaging Market Research by Company, Type & Application 2013-2025

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Abstracts

SUMMARY

A semiconductor package is a metal, plastic, glass or ceramic casing containing one or more semiconductor electronic components.

Market Segment as follows:

By Type

DIP

QFP

SiP

BGA

CSP

Others

By Application

Analog & Mixed Signal

Wireless Connectivity

Optoelectronic

MEMS & Sensor

Misc Logic and Memory

By Company

ASE

Amkor

SPIL

Stats Chippac

PTI

JCET

J-Devices

UTAC

Chipmos

Chipbond

STS

Huatian

NFM

Carsem

Walton

Unisem

OSE

AOI

Formosa

NEPES.

The main contents of the report including:

Section 1:

Product definition, type and application, global and China market overview;

Section 2:

Global and China Market competition by company;

Section 3:

Global and China sales revenue, volume and price by type;

Section 4:

Global and China sales revenue, volume and price by application;

Section 5:

China export and import;

Section 6:

Company information, business overview, sales data and product specifications;

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